

PLASTIC DIODE RELIABILITY TEST PROGRAM

Test Items	Test Conditions	Sampling Plan	Frequency
High Temperature Storage Test	$T_a = T_{\text{stg Max.}} \pm 5^\circ\text{C}$ 168+16/-10hrs	Sample size : 40 pcs Ac/Re: 0/1	Once / Month
Low Temperature Storage Test	$T_a = T_{\text{stg Min.}} \pm 5^\circ\text{C}$ 168+16/-10hrs	Sample size : 40 pcs Ac/Re: 0/1	Once / Month
High Temperature Reverse Bias Test (HTRB)	$V_R(V_Z) = V_{R\text{Max.}}$, $T_a = T_j \pm 5^\circ\text{C}$ $R_L = 5\Omega$, 168+16/-10hrs	Sample size : 40 pcs Ac/Re: 0/1	Once / Month
Alternating Current/Voltage Test (Switching Diode, Rectifier Diode, Schottky Diode, AFC Diode)	$V_R = V_{R\text{Max.}}$ $f = 50\text{Hz}$, $R_L = 510\Omega$ 168+16/-10hrs, $T_a = 25 \pm 5^\circ\text{C}$	Sample size : 40 pcs Ac/Re: 0/1	Once / Month
Continuous Operation Test (Zener Diode)	$P_{\text{tot}} = UI$ $R_L = 5\Omega$ 168+16/-10 hrs, $T_a = 25 \pm 5^\circ\text{C}$	Sample size : 40 pcs Ac/Re: 0/1	Once / Month
Constant Temperature/Humidity Storage Test	$T_a = 85 \pm 5^\circ\text{C}$, $RH = 85 \pm 5\%$ 168+16/-10 hrs	Sample size : 40 pcs Ac/Re: 0/1	Once / Month
Temperature Cycling Test	$T_{\text{stg Min.}}$, 30+2/-0 min ; 25±5°C, 10+2/-0 min ; $T_{\text{stg Max.}}$, 30+2/-0 min ; 25±5°C, 10+2/-0 min; (10 Cycles)	Sample size : 40 pcs Ac/Re: 0/1	Once / Month
Solder Heat Resistance Test	Solder temperature: $260 \pm 5^\circ\text{C}$ immersion time: 10 +2/-0 sec	Sample size : 40 pcs Ac/Re: 0/1	Once / Month
High Pressure / High Humidity / High Temperature Test (PCT)	Vapor Pressure= 1.05kg/cm^2 $RH = 100\%$, $T_a = 121^\circ\text{C}$ 24+2/-0 hrs	Sample size : 40 pcs Ac/Re: 0/1	Once / Month
Solderability Test	$245 \pm 5^\circ\text{C}$ for 5 ± 1 sec Sn100%	Sample size : 10 pcs Ac/Re: 0/1	Once / Month
Marking Permanence Test (DO-213AA Package Products)	Put the products into the ultrasonic cleaning machine filled with ethanol 20sec	Sample size : 10 pcs Ac/Re: 0/1	Once / Month